

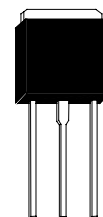


# HI13003

NPN EPITAXIAL PLANAR TRANSISTOR

## Description

These devices are designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. They are particularly suited for 115 and 220V switchmode applications such as Switching Regulators, Inverters, Motor Controls, Solenoid/Relay drivers and Deflection circuits.



TO-251

## Absolute Maximum Ratings (Ta=25°C)

- Maximum Temperatures  
Storage Temperature ..... -55 ~ +150 °C  
Junction Temperature ..... 150 °C Maximum
- Maximum Power Dissipation  
Total Power Dissipation (Tc=25°C) ..... 40 W  
Total Power Dissipation (Ta=25°C) ..... 1.3 W
- Maximum Voltages and Currents (Ta=25°C)  
BVCEO Collector to Emitter Voltage ..... 700 V  
VCEO Collector to Emitter Voltage ..... 400 V  
VEBO Emitter to Base Voltage ..... 9 V  
IC Collector Current ..... 1.5 A

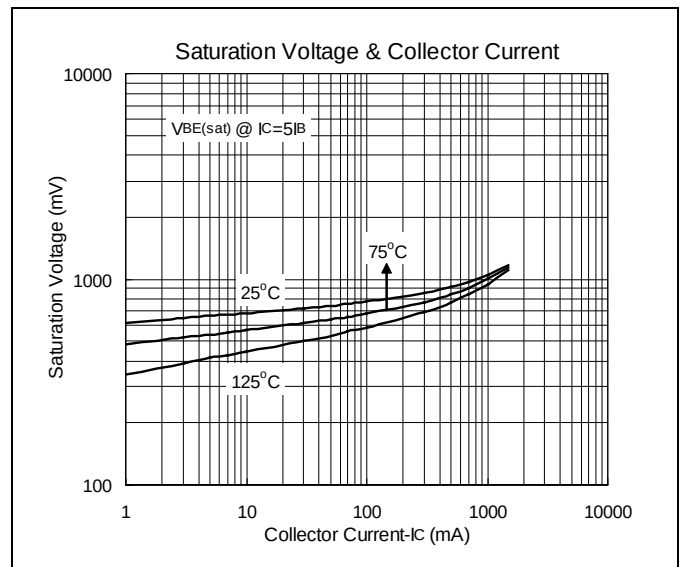
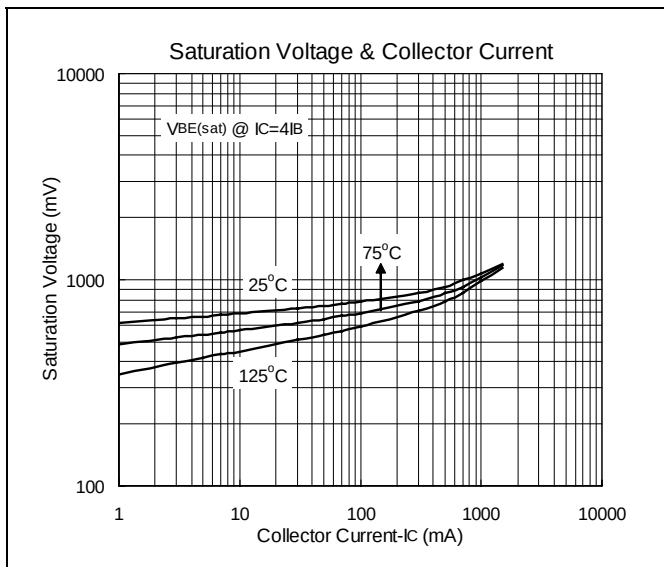
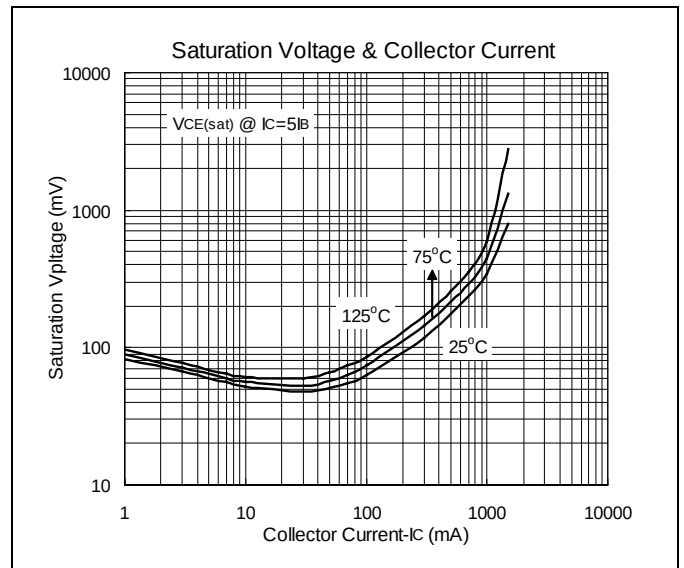
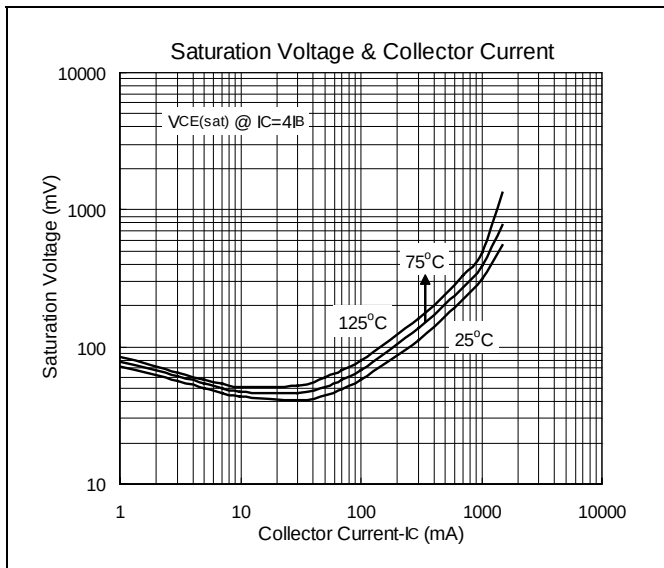
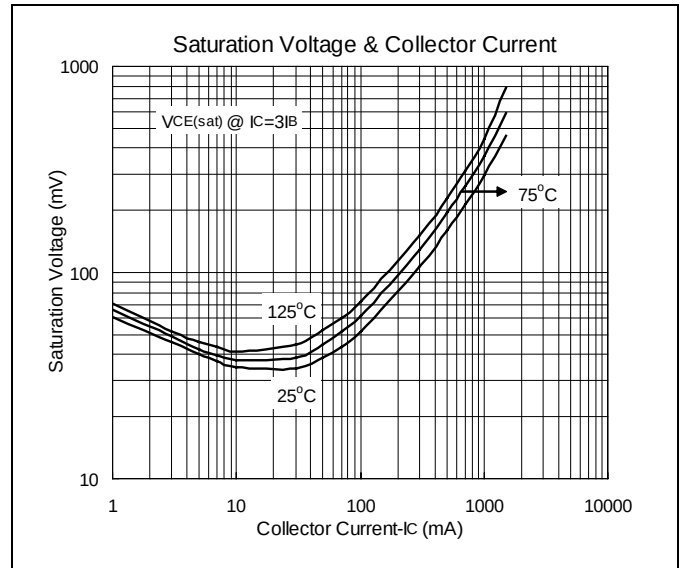
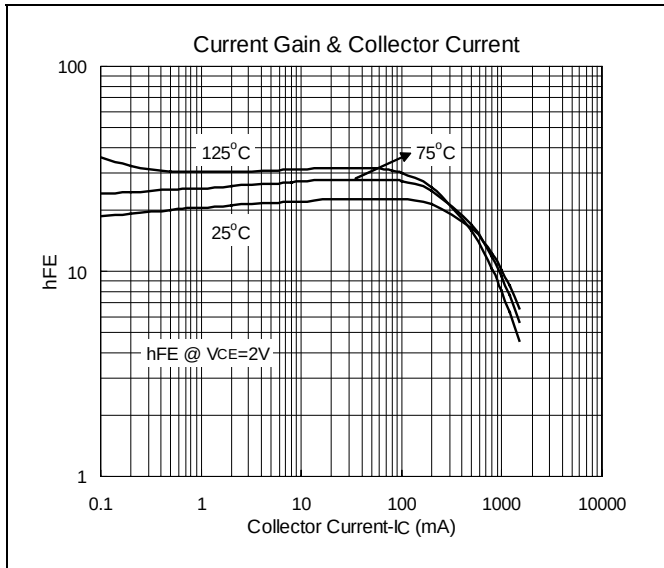
## Characteristics (Ta=25°C)

| Symbol     | Min. | Typ. | Max. | Unit | Test Conditions         |
|------------|------|------|------|------|-------------------------|
| BVCEO      | 400  | -    | -    | V    | IC=10mA                 |
| BVCEV      | 700  | -    | -    | V    | IC=1mA, VBE(OFF)=1.5V   |
| IEBO       | -    | -    | 1    | mA   | VEB=9V                  |
| ICEV       | -    | -    | 1    | mA   | VCE=700V, VBE(OFF)=1.5V |
| *VCE(sat)1 | -    | -    | 0.5  | V    | IC=0.5A, IB=0.1A        |
| *VCE(sat)2 | -    | -    | 1    | V    | IC=1A, IB=0.25A         |
| *VCE(sat)3 | -    | -    | 3    | V    | IC=1.5A, IB=0.5A        |
| *VBE(sat)1 | -    | -    | 1    | V    | IC=0.5A, IB=0.1A        |
| *VBE(sat)2 | -    | -    | 1.2  | V    | IC=1A, IB=0.25A         |
| *hFE1      | 8    | -    | 40   |      | IC=0.5A, VCE=2V         |
| *hFE2      | 5    | -    | 25   |      | VCE=2V, IC=1A           |
| Cob        | -    | 21   | -    | pF   | VCB=10V, IE=0, f=1MHz   |

\*Pulse Test: Pulse Width ≤380us, Duty Cycle≤2%

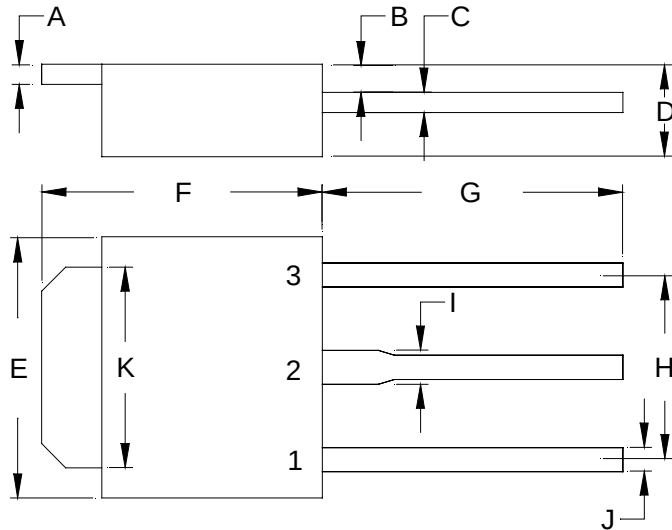


## Characteristics Curve



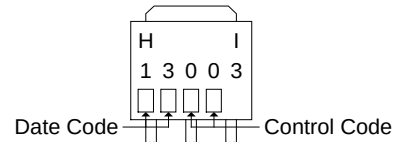


### TO-251 Dimension



3-Lead TO-251 Plastic Package  
HSMC Package Code: I

#### Marking:



Style: Pin 1.Base 2.Collector 3.Emitter

\*: Typical

| DIM | Inches |        | Millimeters |      | DIM | Inches |         | Millimeters |       |
|-----|--------|--------|-------------|------|-----|--------|---------|-------------|-------|
|     | Min.   | Max.   | Min.        | Max. |     | Min.   | Max.    | Min.        | Max.  |
| A   | 0.0177 | 0.0217 | 0.45        | 0.55 | G   | 0.2559 | -       | 6.50        | -     |
| B   | 0.0354 | 0.0591 | 0.90        | 1.50 | H   | -      | *0.1811 | -           | *4.60 |
| C   | 0.0177 | 0.0236 | 0.45        | 0.60 | I   | -      | 0.0354  | -           | 0.90  |
| D   | 0.0866 | 0.0945 | 2.20        | 2.40 | J   | -      | 0.0315  | -           | 0.80  |
| E   | 0.2520 | 0.2677 | 6.40        | 6.80 | K   | 0.2047 | 0.2165  | 5.20        | 5.50  |
| F   | 0.2677 | 0.2835 | 6.80        | 7.20 |     |        |         |             |       |

Notes: 1.Dimension and tolerance based on our Spec. dated May. 24,1995.  
2.Controlling dimension: millimeters.  
3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.  
4.If there is any question with packing specification or packing method, please contact your local HSMC sales office.

#### Material:

- Lead: 42 Alloy; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0

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